

# 100V 1.25mohm N-channel SGT MOSFET

## AKG10N012TM-A

### Description:

This device is designed for automotive applications and manufactured in IATF16949 certified facilities. Qualified AEC-Q101, PPAP capable.

### Features:

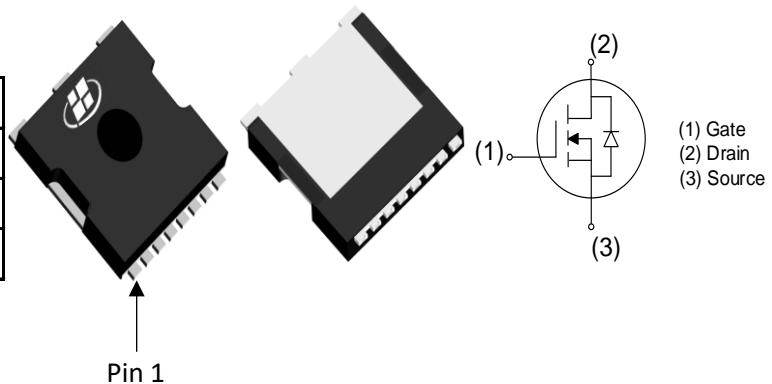
- Ultra-low on-resistance
- RoHS compliant <sup>(Note 1)</sup>
- Halogen-free <sup>(Note 1)</sup>
- 100% UIS tested
- AEC-Q101 qualified and PPAP capable
- Wettable Flank for Improved Optical Inspection

### Applications:

- Battery Management System
- Motor Drivers
- DC-DC Converter

### Key Performance Parameters:

Parameter	Value	Unit
$V_{DS}$	100	V
$R_{DS(ON, \text{max})} @ V_{GS} = 10 \text{ V}$	1.25	mΩ
$I_D$	300	A



### Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKG10N012TM-A	TOLL	G10N012TM	Tape Reel	See the detail package information

### Notes:

1. Contact ALKAIDSEMI sales for detail information

## Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-Source Voltage	100	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ ) <sup>(Note 1)</sup>	367	A
	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ ) <sup>(Note 2)</sup>	300	A
	Drain Current - Continuous ( $T_C = 100^\circ\text{C}$ )	260	A
$I_{DM}$	Drain Current - Pulsed <sup>(Note 3)</sup>	1200	A
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(Note 4)</sup>	1600	mJ
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	300	W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +175	°C

## Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady-State	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State <sup>(Note 5)</sup>	50	°C/W

### Notes:

1. The max drain current rating is silicon limited
2. The max drain current rating is package limited
3. Repetitive Rating: Pulse width limited by maximum junction temperature
4.  $L = 0.5 \text{ mH}$ ,  $V_{DD} = 50 \text{ V}$ ,  $I_{AS} = 80 \text{ A}$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^\circ\text{C}$
5. Mount on minimum PCB layout

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Static Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	100			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 80 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$			1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}} = \pm 20 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$			$\pm 100$	nA
$V_{\text{GS(TH)}}$	Gate Threshold voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250 \mu\text{A}$	2	2.8	4	V
$R_{\text{DS(ON)}}$	Drain-Source on-state resistance	$V_{\text{GS}} = 10 \text{ V}$ , $I_D = 20 \text{ A}$		0.98	1.25	$\text{m}\Omega$

**Dynamic Characteristics**

$C_{\text{ISS}}$	Input Capacitance	$V_{\text{DS}} = 50 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$ , $F = 1 \text{ MHz}$	20760			pF
$C_{\text{OSS}}$	Output Capacitance		4310			pF
$C_{\text{RSS}}$	Reverse Transfer Capacitance		117			pF
$R_G$	Gate Resistance	$F = 1 \text{ MHz}$		2.3		$\Omega$

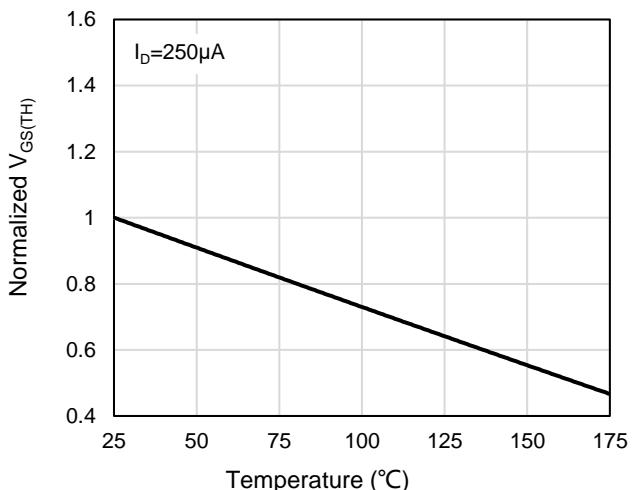
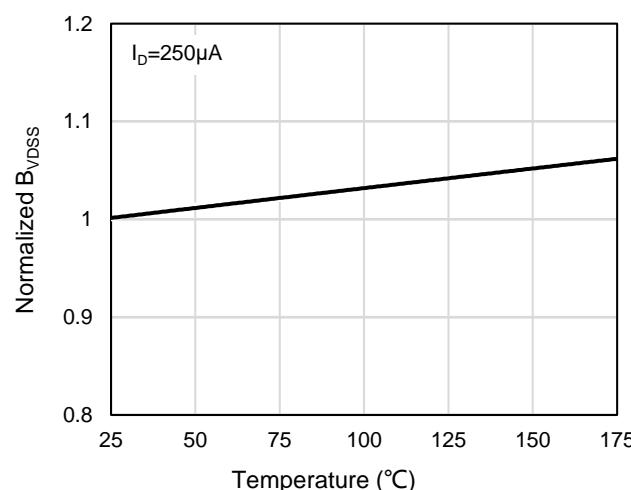
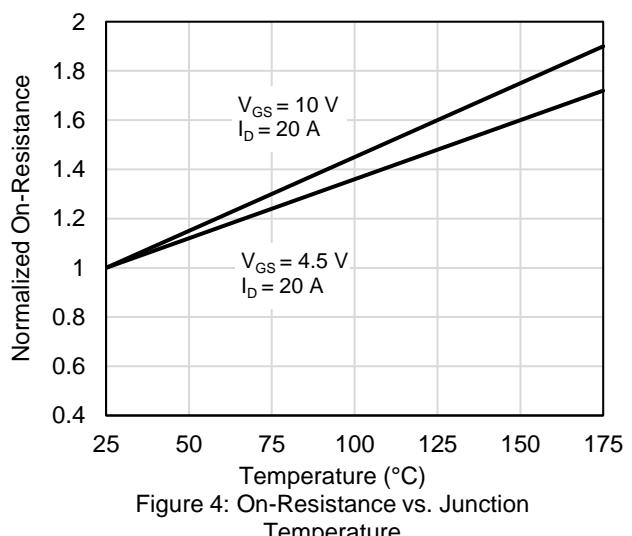
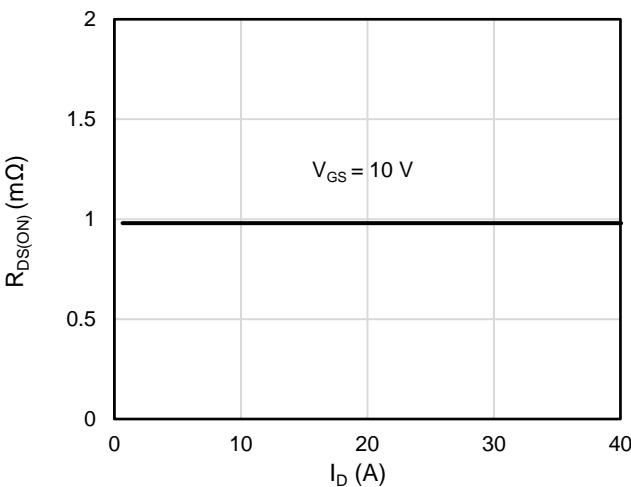
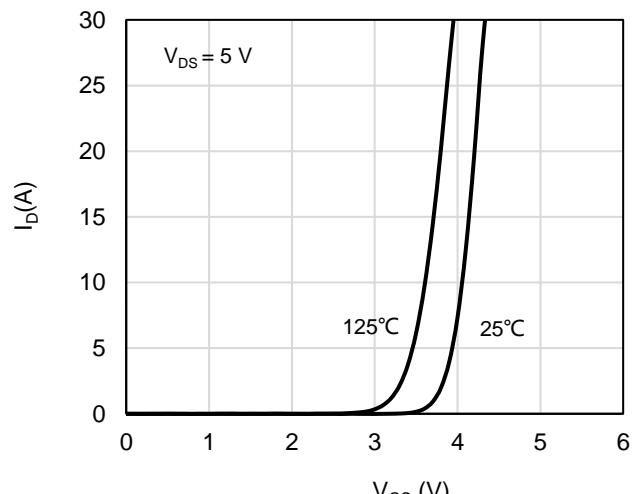
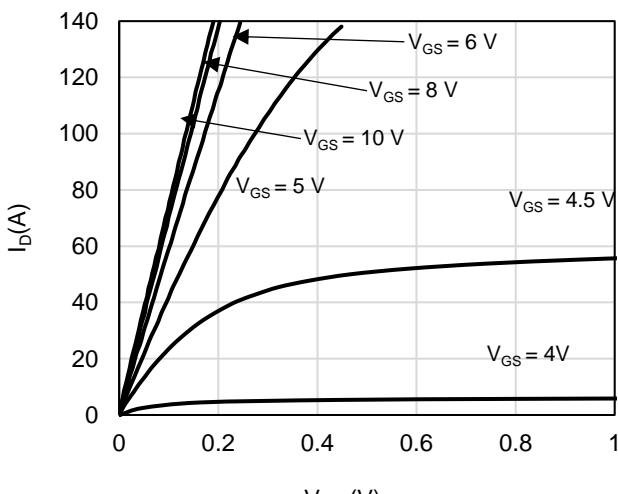
**Switching Characteristics**

$T_{\text{D(ON)}}$	Turn On Delay Time	$V_{\text{DD}} = 50 \text{ V}$ , $R_L = 2.5 \Omega$ , $V_{\text{GS}} = 10 \text{ V}$ , $R_G = 1.6 \Omega$		49		nS
$T_R$	Rise Time			48.0		nS
$T_{\text{D(OFF)}}$	Turn Off Delay Time			143		nS
$T_F$	Fall Time			63		nS
$Q_G$	Total Gate Charge	$V_{\text{DD}} = 50 \text{ V}$ , $I_D = 20 \text{ A}$ , $V_{\text{GS}} = 10 \text{ V}$		291		nC
$Q_{\text{GS}}$	Gate-Source Charge			71		nC
$Q_{\text{GD}}$	Gate-Drain Charge			49		nC

**Drain-Source Diode Characteristics and Maximum Ratings**

$I_S$	Maximum Continuous Body-Diode Forward Current			300	A
$I_{\text{SM}}$	Maximum Pulsed Body-Diode Forward Current			1200	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_S = 20 \text{ A}$		0.85	V
$T_{\text{RR}}$	Reverse recovery time	$V_{\text{DD}} = 50 \text{ V}$ , $I_D = 20 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$		133	nS
$Q_{\text{RR}}$	Reverse recovery charge			374	nC
$I_{\text{RRM}}$	Peak Reverse Recovery Current			5	A

## Electrical Characteristics Diagrams



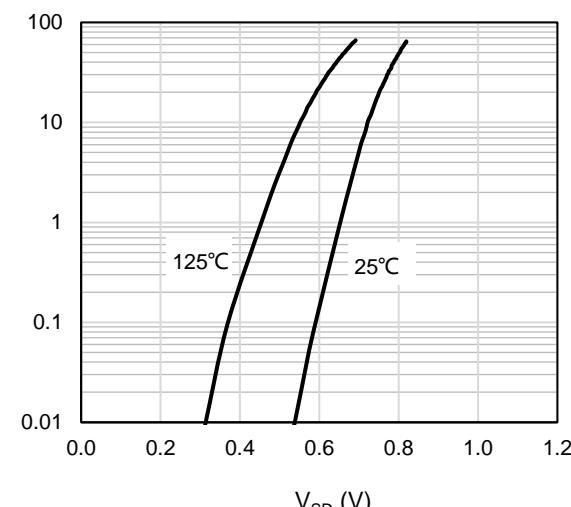


Figure 7: Body-Diode Characteristics

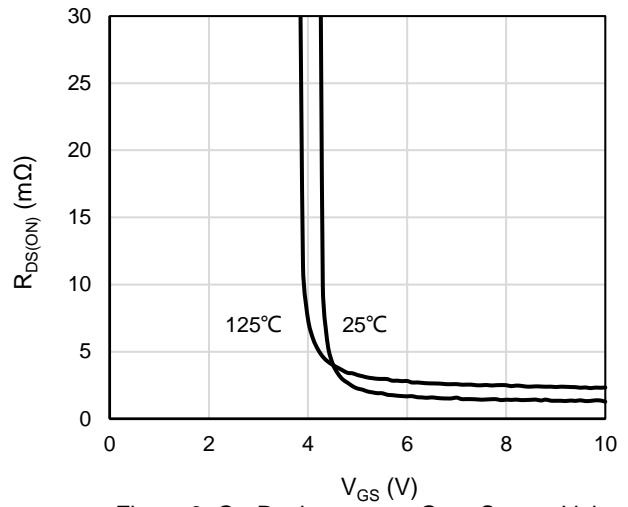


Figure 8: On-Resistance vs. Gate-Source Voltage

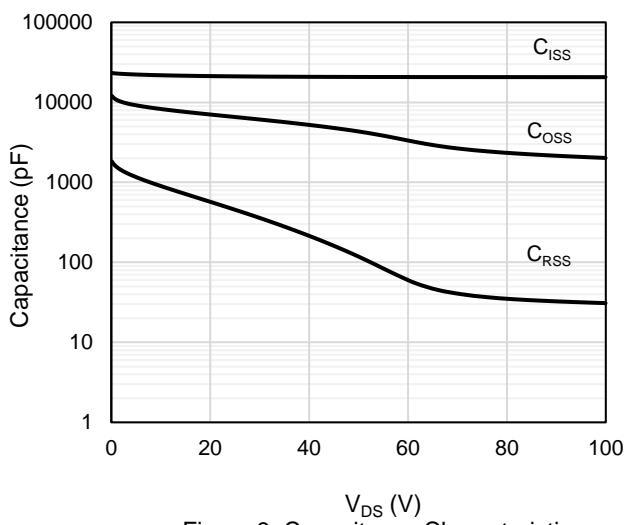


Figure 9: Capacitance Characteristics

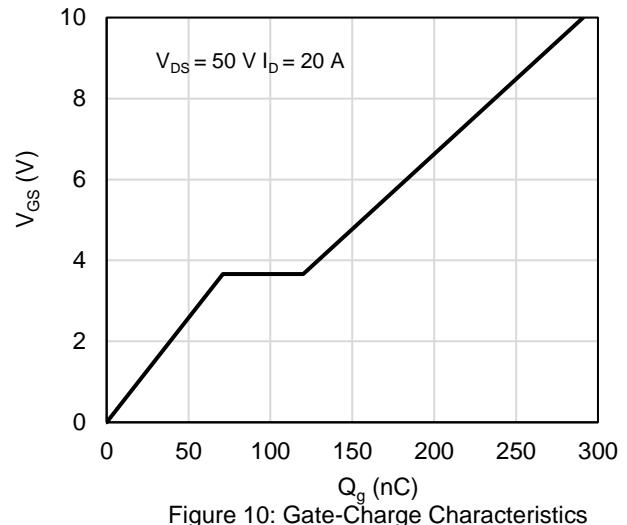


Figure 10: Gate-Charge Characteristics

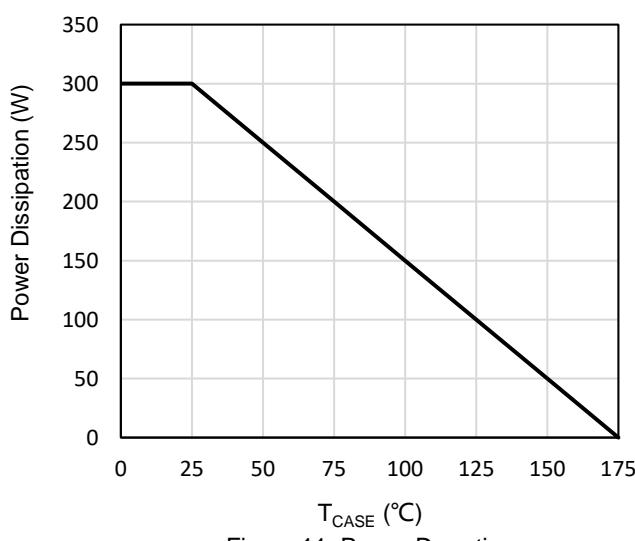


Figure 11: Power De-rating

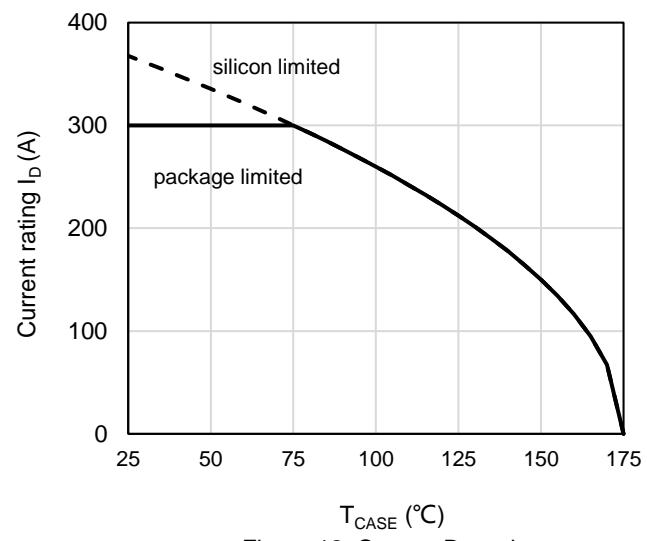


Figure 12: Current De-rating

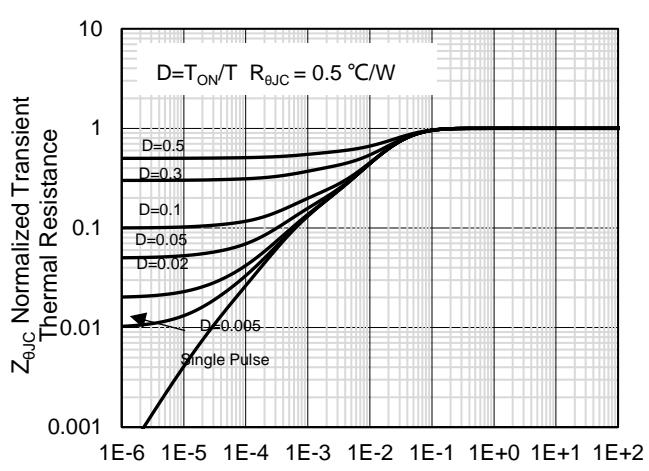


Figure 13: Normalized Maximum Transient Thermal Impedance

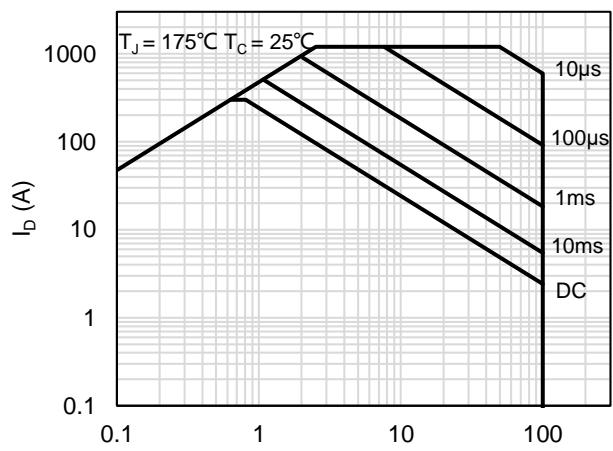
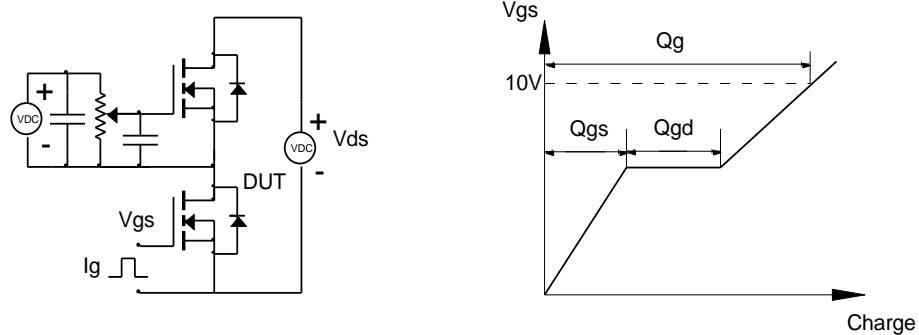


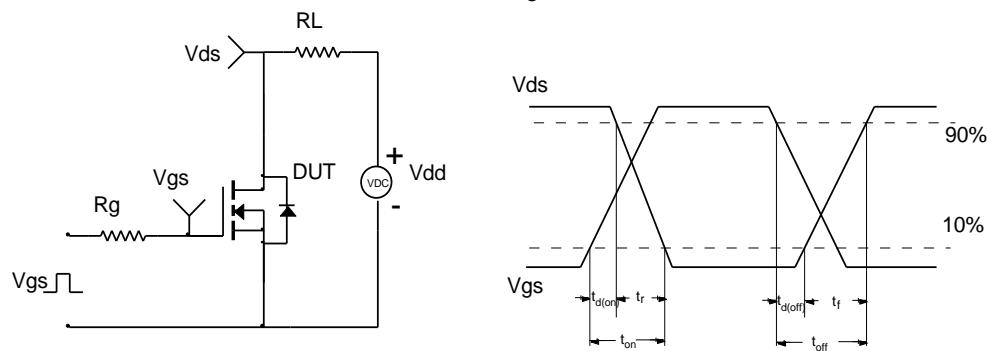
Figure 14: Maximum Forward Biased Safe Operating Area

## Test Circuit and Waveform

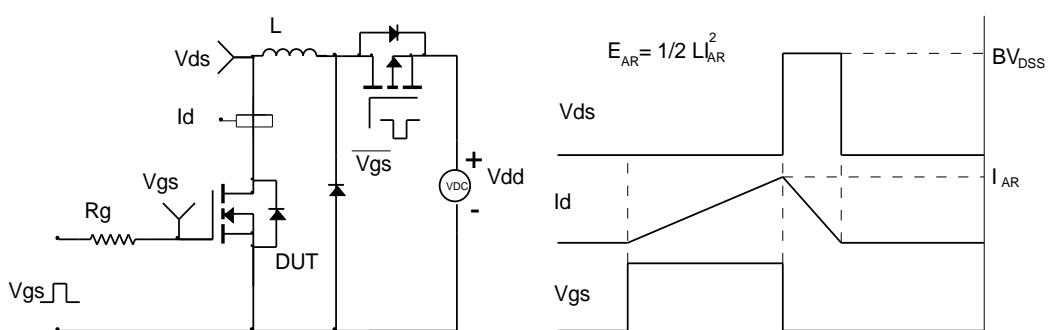
Gate Charge Test Circuit &amp; Waveform



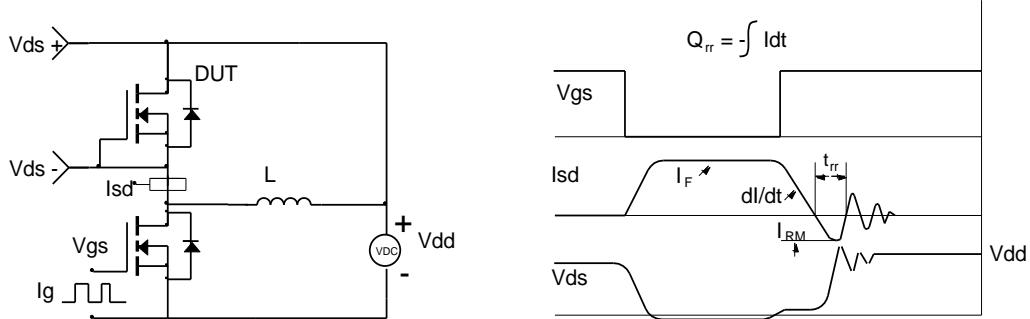
Resistive Switching Test Circuit &amp; Waveforms



Unclamped Inductive Switching (UIS) Test Circuit &amp; Waveforms



Diode Recovery Test Circuit &amp; Waveforms



## Revision History

Revision	Release Date	Remark
Rev.1.1	2023/3/1	

## Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.